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# AOT8N65/AOTF8N65

650V, 8A N-Channel MOSFET

## **General Description**

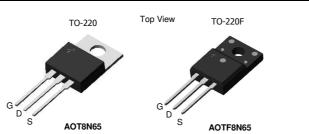
The AOT8N65 & AOTF8N65 have been fabricated using an advanced high voltage MOSFET process that is designed to deliver high levels of performance and robustness in popular AC-DC applications. By providing low  $R_{\rm DS(on)},\,C_{\rm iss}$  and  $C_{\rm rss}$  along with guaranteed avalanche capability these parts can be adopted quickly into new and existing offline power supply designs.

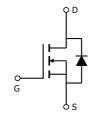
For Halogen Free add "L" suffix to part number: AOT8N65L & AOTF8N65L

# **Product Summary**

100% UIS Tested 100%  $R_q$  Tested







Absolute Maximum Ratings T₄=25℃ unless otherwise noted									
	Symbol	AOT8N65	AOTF8N65	Units					
	V <sub>DS</sub>	650		V					
	$V_{GS}$	±30		V					
	I <sub>D</sub>	8 5.2	8* 5.2*	A					
	I <sub>DM</sub>	32		,,					
	I <sub>AR</sub>	3.4		Α					
С	E <sub>AR</sub>	173		mJ					
rgy <sup>G</sup>	E <sub>AS</sub>	347		mJ					
ak diode recovery dv/dt		5		V/ns					
$\mathcal{C}$	D_	208	50.0	W					
above 25°C		1.67	0.3	W/ °C					
Junction and Storage Temperature Range		-55 to 150		C					
Maximum lead temperature for soldering ourpose, 1/8" from case for 5 seconds Thermal Characteristics		300		.C					
	,	T	1	1					
	Symbol	AOT8N65	AOTF8N65	Units					
Maximum Junction-to-Ambient A,D		65	65	℃/W					
Maximum Case-to-sink <sup>A</sup>		0.5		°C/W					
Maximum Junction-to-Case		0.6	2.5	℃/W					
	C oC oC oC oc rgy G c above 25°C rature Range or soldering seconds r	Symbol   V <sub>DS</sub>   V <sub>D</sub>	Symbol   AOT8N65     V <sub>DS</sub>   6     V <sub>GS</sub>   ±     C   I <sub>D</sub>   8     O°C   I <sub>D</sub>   5.2     I <sub>AR</sub>   3     C   E <sub>AR</sub>   1     E <sub>AS</sub>   3     dv/dt     C   P <sub>D</sub>   208     e above 25°C   7, T <sub>STG</sub>   -55 t     or soldering   seconds   T <sub>L</sub>   3     r   Symbol   AOT8N65     T <sub>A</sub> , T <sub>B</sub>   65     T <sub>B</sub> , T <sub>B</sub>   0.5     T <sub>B</sub> , T <sub>B</sub>   65     T <sub>B</sub> , T <sub>B</sub>   0.5     T <sub>B</sub> , T <sub>B</sub> , T <sub>B</sub>   65     T <sub>B</sub> , T <sub>B</sub> , T <sub>B</sub>   0.5     T <sub>B</sub> , T <sub>B</sub> , T <sub>B</sub>   0.5     T <sub>B</sub> , T <sub>B</sub> , T <sub>B</sub>   0.5     T <sub>B</sub> ,	Symbol   AOT8N65   AOTF8N65     V <sub>DS</sub>   650     V <sub>GS</sub>   ±30     C					

<sup>\*</sup> Drain current limited by maximum junction temperature.



#### Electrical Characteristics (T<sub>J</sub>=25℃ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Max	Units			
STATIC PARAMETERS									
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$I_D=250\mu A, V_{GS}=0V, T_J=25^{\circ}C$	650						
		$I_D=250\mu A, \ V_{GS}=0V, \ T_J=150 ^{\circ} C$		750		V			
$BV_{DSS}$	Zero Gate Voltage Drain Current					V/°C			
/∆TJ		ID=250µA, VGS=0V		0.7					
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS}$ =650V, $V_{GS}$ =0V	. 43		1	μΑ			
		V <sub>DS</sub> =520V, T <sub>J</sub> =125℃			10	F .			
$I_{GSS}$	Gate-Body leakage current	$V_{DS}=0V$ , $V_{GS}=\pm30V$			±100	nA			
$V_{GS(th)}$	Gate Threshold Voltage	V <sub>DS</sub> =5V I <sub>D</sub> =250μA	3	4	4.5	V			
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance	$V_{GS}=10V$ , $I_D=4A$		0.91	1.15	Ω			
g <sub>FS</sub>	Forward Transconductance	$V_{DS}$ =40V, $I_{D}$ =4A		11		S			
$V_{SD}$	Diode Forward Voltage	$I_S=1A,V_{GS}=0V$		0.74	1	٧			
$I_S$	Maximum Body-Diode Continuous Current				8	Α			
I <sub>SM</sub>	Maximum Body-Diode Pulsed Current				32	Α			
DYNAMIC	PARAMETERS								
C <sub>iss</sub>	Input Capacitance		930	1165	1400	pF			
C <sub>oss</sub>	Output Capacitance	$V_{GS}$ =0V, $V_{DS}$ =25V, f=1MHz	80	101	120	pF			
$C_{rss}$	Reverse Transfer Capacitance		7	9	11	рF			
$R_g$	Gate resistance	$V_{GS}$ =0V, $V_{DS}$ =0V, f=1MHz	1.8	3.7	5.6	Ω			
SWITCHING PARAMETERS									
$Q_g$	Total Gate Charge		18.5	23.5	28	nC			
$Q_{gs}$	Gate Source Charge	$V_{GS} = 10V, V_{DS} = 520V, I_{D} = 8A$	5	6.2	7.5	nC			
$Q_{gd}$	Gate Drain Charge		7.5	9.5	11.5	nC			
t <sub>D(on)</sub>	Turn-On DelayTime			26		ns			
t <sub>r</sub>	Turn-On Rise Time	V <sub>GS</sub> =10V, V <sub>DS</sub> =325V, I <sub>D</sub> =8A, R <sub>G</sub> =25Ω		51		ns			
t <sub>D(off)</sub>	Turn-Off DelayTime	7 v <sub>GS</sub> =10 v, v <sub>DS</sub> =323 v, I <sub>D</sub> =0A, R <sub>G</sub> =2512		65		ns			
t <sub>f</sub>	Turn-Off Fall Time	]		43		ns			
t <sub>rr</sub>	Body Diode Reverse Recovery Time	$I_F=8A,dI/dt=100A/\mu s,V_{DS}=100V$	235	295	355	ns			
$Q_{rr}$	Body Diode Reverse Recovery Charge	$I_F=8A,dI/dt=100A/\mu s,V_{DS}=100V$	4	5	6	μC			

A. The value of R  $_{\theta JA}$  is measured with the device in a still air environment with T  $_A$  =25°C.

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B. The power dissipation  $P_D$  is based on  $T_{J(MAX)}=150$ °C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.

C. Repetitive rating, pulse width limited by junction temperature T<sub>J(MAX)</sub>=150°C, Ratings are based on low frequency and duty cycles to keep initial T<sub>J</sub> =25°C.

D. The R  $_{\theta JA}$  is the sum of the thermal impedence from junction to case R  $_{\theta JC}$  and case to ambient.

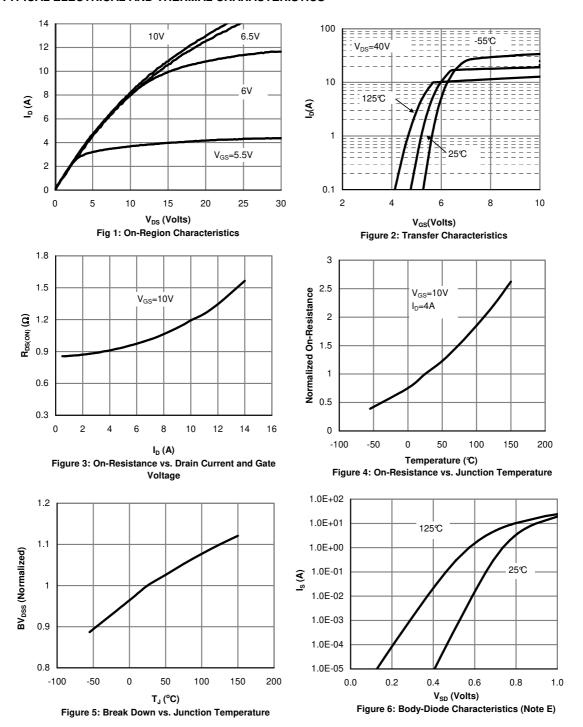
E. The static characteristics in Figures 1 to 6 are obtained using <300  $\mu s$  pulses, duty cycle 0.5% max.

F. These curves are based on the junction-to-case thermal impedence which is measured with the device mounted to a large heatsink, assuming a maximum junction temperature of  $T_{J(MAX)}$ =150°C. The SOA curve provides a single pulse ratin g.

G. L=60mH, I<sub>AS</sub>=3.3A, V<sub>DD</sub>=150V, R<sub>G</sub>=25  $\Omega$ , Starting T<sub>J</sub>=25  $^{\circ}$ C

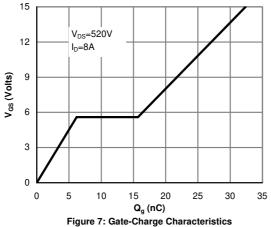


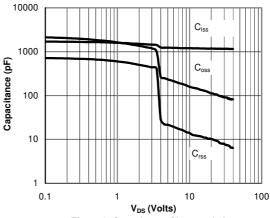
#### TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

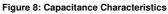


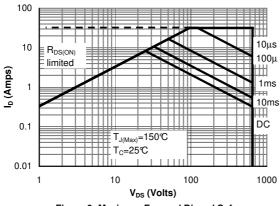


#### TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS









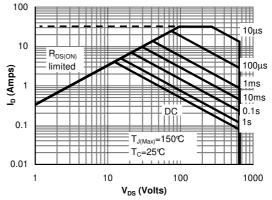


Figure 9: Maximum Forward Biased Safe Operating Area for AOT8N65 (Note F)

Figure 10: Maximum Forward Biased Safe Operating Area for AOTF8N65 (Note F)

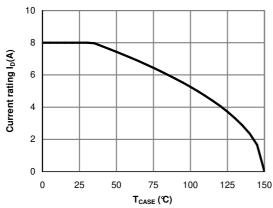


Figure 11: Current De-rating (Note B)

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#### TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

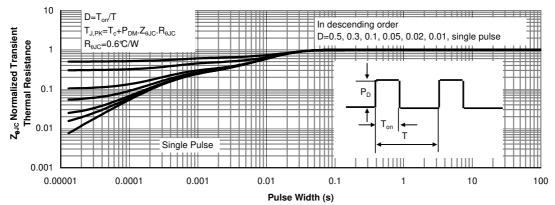


Figure 12: Normalized Maximum Transient Thermal Impedance for AOT8N65 (Note F)

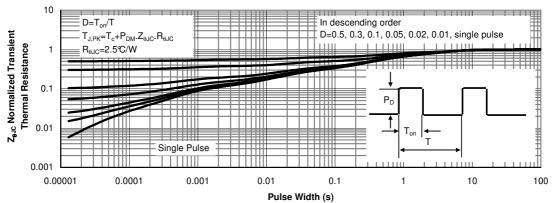
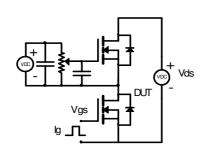


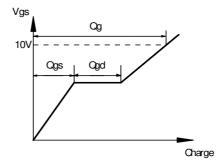
Figure 13: Normalized Maximum Transient Thermal Impedance for AOTF8N65 (Note F)

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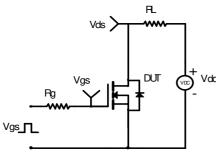


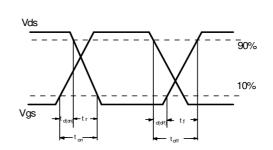
## Gate Charge Test Circuit & Waveform



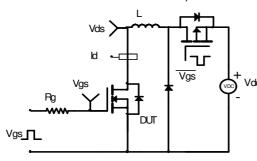


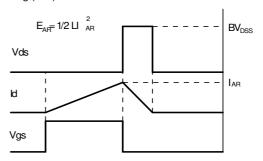
Resistive Switching Test Circuit & Waveforms





Unclamped Inductive Switching (UIS) Test Circuit & Waveforms





Diode Recovery Test Circuit & Waveforms

